

April 1988 Revised August 2000

74F32

Quad 2-Input OR Gate

General Description

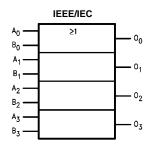
This device contains four independent gates, each of which performs the logic OR function.

Ordering Code:

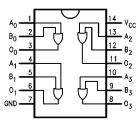
		,
Order Number	Package Number	Package Description
74F32SC	M14A	14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-120, 0.150 Narrow
74F32SJ	M14D	14-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
74F32MTC	MTC14	14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide
74F32PC	N14A	14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Wide

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

Logic Symbol



Connection Diagram



Unit Loading/Fan Out

Pin Names	Description	U.L. HIGH/LOW	Input I _{IH} /I _{IL} Output I _{OH} /I _{OL}		
A _n , B _n	Inputs	1.0/1.0	20 μA/-0.6 mA		
O _n	Outputs	50/33.3	−1 mA/20 mA		

Absolute Maximum Ratings(Note 1)

 $\begin{array}{ll} \mbox{Storage Temperature} & -65^{\circ}\mbox{C to } +150^{\circ}\mbox{C} \\ \mbox{Ambient Temperature under Bias} & -55^{\circ}\mbox{C to } +125^{\circ}\mbox{C} \\ \end{array}$

Voltage Applied to Output in HIGH State (with $V_{CC} = 0V$)

Input Current (Note 2)

 $\begin{array}{ll} \mbox{Standard Output} & -0.5\mbox{V to V}_{\mbox{CC}} \\ \mbox{3-STATE Output} & -0.5\mbox{V to } +5.5\mbox{V} \end{array}$

-30 mA to +5.0 mA

Current Applied to Output

Recommended Operating Conditions

Free Air Ambient Temperature 0°C to +70°C Supply Voltage +4.5V to +5.5V

Note 1: Absolute maximum ratings are values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.

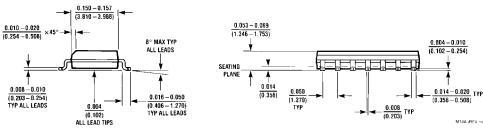
Note 2: Either voltage limit or current limit is sufficient to protect inputs.

DC Electrical Characteristics

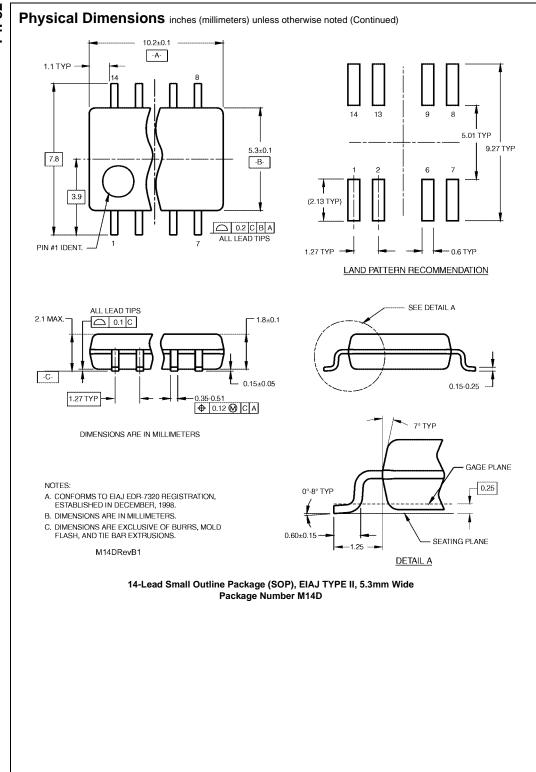
Symbol	Parameter		Min	Тур	Max	Units	v _{cc}	Conditions	
V _{IH}	Input HIGH Voltage		2.0			V		Recognized as a HIGH Signal	
V _{IL}	Input LOW Voltage				0.8	V		Recognized as a LOW Signal	
V _{CD}	Input Clamp Diode Voltage				-1.2	V	Min	I _{IN} = -18 mA	
V _{OH}	Output HIGH 10	% V _{CC}	2.5			V	Min	I _{OH} = -1 mA	
	Voltage 5	% V _{CC}	2.7					$I_{OH} = -1 \text{ mA}$	
V _{OL}	Output LOW 10	10% V _{CC}			0.5	V	Min	I _{OL} = 20 mA	
	Voltage							I _{OL} = 20 IIIA	
I _{IH}	Input HIGH				5.0	μА	Max	V _{IN} = 2.7V	
	Current				5.0	μА			
I _{BVI}	Input HIGH Current				7.0) μΑ	Max	V _{IN} = 7.0V	
	Breakdown Test				7.0			v _{IN} = 7.0 v	
I _{CEX}	Output HIGH				50	μА	Max	V _{OUT} = V _{CC}	
	Leakage Current							AOOI — ACC	
V _{ID}	Input Leakage		4.75			٧	0.0	I _{ID} = 1.9 μA	
	Test							All Other Pins Grounded	
I _{OD}	Output Leakage				3.75	μА	0.0	V _{IOD} = 150 mV	
	Circuit Current			3	3.73	μΑ	0.0	All Other Pins Grounded	
I _{IL}	Input LOW Current				-0.6	mA	Max	V _{IN} = 0.5V	
Ios	Output Short-Circuit Current		-60		-150	mA	Max	$V_{OUT} = 0V$	
I _{CCH}	Power Supply Current			6.1	9.2	mA	Max	V _O = HIGH	
I _{CCL}	Power Supply Current			10.3	15.5	mA	Max	$V_O = LOW$	

AC Electrical Characteristics

Symbol	Parameter	$T_A = +25^{\circ}C$ $V_{CC} = +5.0V$ $C_L = 50 \text{ pF}$			$T_{A} = -55^{\circ}\text{C to } +125^{\circ}\text{C}$ $V_{CC} = +5.0\text{V}$ $C_{L} = 50 \text{ pF}$		$T_A = 0$ °C to +70°C $V_{CC} = +5.0V$ $C_L = 50 \text{ pF}$		Units	
		Min	Тур	Max	Min	Max	Min	Max		
t _{PLH}	Propagation Delay	3.0	4.2	5.6	3.0	7.5	3.0	6.6	ns	
t _{PHL}	A _n , B _n to O _n	3.0	4.0	5.3	2.5	7.5	3.0	6.3	115	

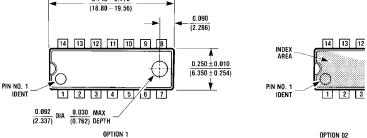


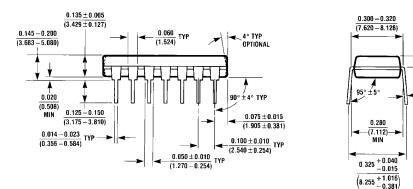
14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-120, 0.150 Narrow Package Number M14A



Physical Dimensions inches (millimeters) unless otherwise noted (Continued) 5.0±0.1 -A-7.72 4.16 6.4 4.4±0.1 -B-3.2 0.2 C B A 0.65 ALL LEAD TIPS LAND PATTERN RECOMMENDATION PIN #1 IDENT. - SEE DETAIL A ALL LEAD TIPS 1.2 MAX - 0.90 +0.15 - 0.09-0.20 -C-- 0.10±0.05 0.19 - 0.30 **♦** 0.13 **№** A B**⑤** C**⑤** -12.00° TOP & BOTTOM R0.09 MIN-GAGE PLANE NOTES: A. CONFORMS TO JEDEC REGISTRATION MO-153, VARIATION AB, REF NOTE 6, DATE 7/93. 0.25 B. DIMENSIONS ARE IN MILLIMETERS. C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS. SEATING PLANE D. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M, 1982. -1.00-R0.09 MIN MTC14RevC3 DETAIL A 14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide Package Number MTC14

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)





14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Wide Package Number N14A

Fairchild does not assume any responsibility for use of any circuitry described, no circuit patent licenses are implied and Fairchild reserves the right at any time without notice to change said circuitry and specifications.

LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF THE PRESIDENT OF FAIRCHILD SEMICONDUCTOR CORPORATION. As used herein:

- Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury to the user.
- A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

www.fairchildsemi.com

(1.651)

 $\frac{0.008 - 0.016}{(0.203 - 0.406)}$ TYP

N144 (REV.F)